

March 8, 2018

**Applied Power Electronics Conference and Exposition (APEC)
IS16-02**



Panasonic

Dynamic High Temperature Operating Life Tests for GaN Hybrid-Drain-embedded GITs – Demonstration of Highly Reliable Operations

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**APEC
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Demonstration of Highly Reliable Operations by Panasonic's 600V GaN Power Transistors

- **GaN Hybrid-Drain-Embedded GIT (HD-GIT) and Its Reliability**
- **Dynamic High Temperature Operating Life (D-HTOL) Test for HD-GIT**
- **Estimation of D-HTOL Lifetime for Totem-pole PFC using HD-GITs**

Panasonic's 600V Gate Injection Transistor (GIT)

- Normally-off operation with low on-state resistance is achieved by a new **Gate Injection Transistor (GIT)**.
- Low cost fabrication is possible on large diameter Si substrate.

Photo of GaN on 6-inch Si

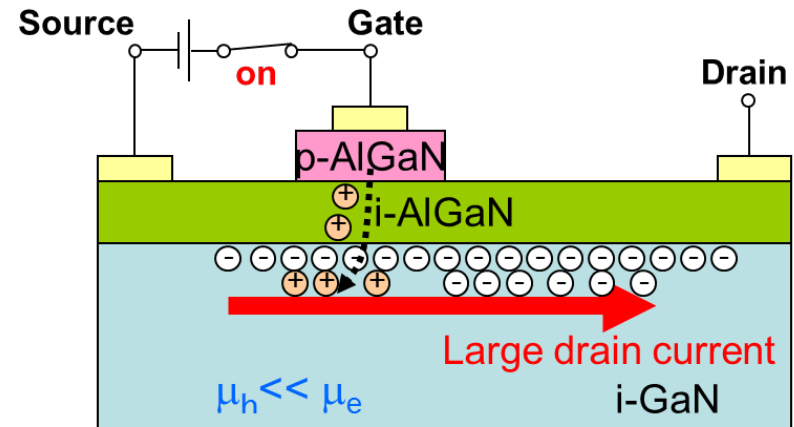


Available Specifications

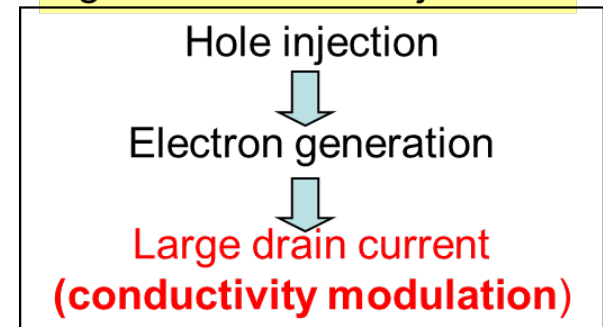
Threshold Voltage V_{th} : +1.2V
On-state Resistance R_{on} : 55m Ω

Rating Drain Current: 26A
Blocking Voltage: 600V

Operating principle of GIT



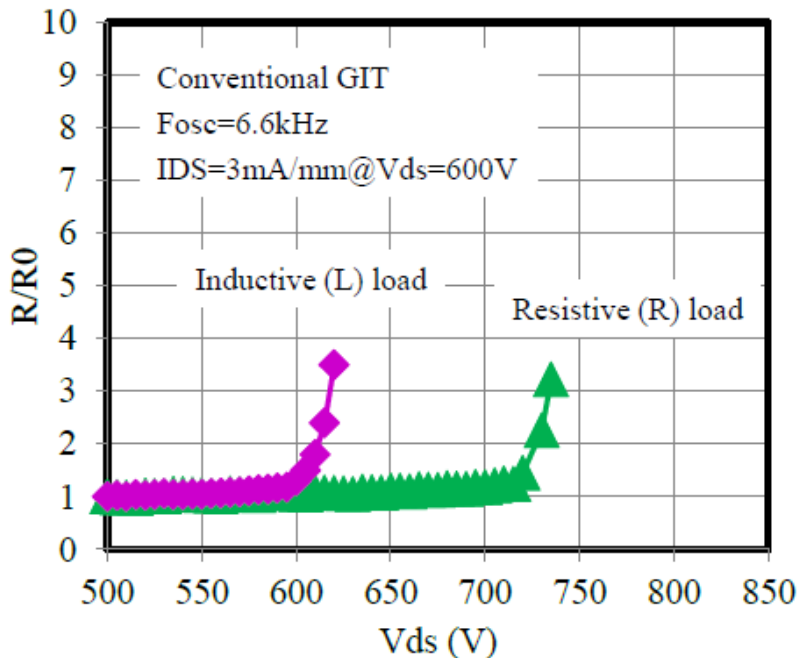
$V_g > V_f$ of GaN-PN junction



Impact of Switching Locus on Current Collapse

- Significant increase of dynamic R_{on} is observed in GITs at high drain voltages under inductive load switching.
- Current collapse of the GIT needs to be suppressed even by the inductive load switching with severe biasing conditions.

Dynamic R_{on} of Conventional GITs Under Multi-pulsed Switching



Evaluation Circuit and Switching Locus

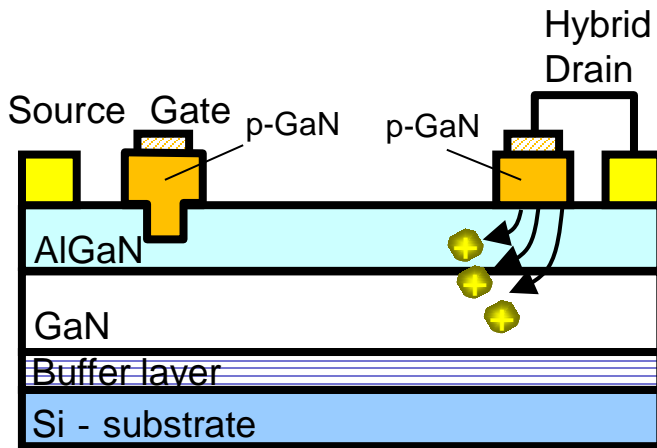
	Evaluation Circuit	Switching Locus
Resistive load		
Inductive load		<p>Semi-on state</p>

HD-GIT for Current-Collapse-Free Operations

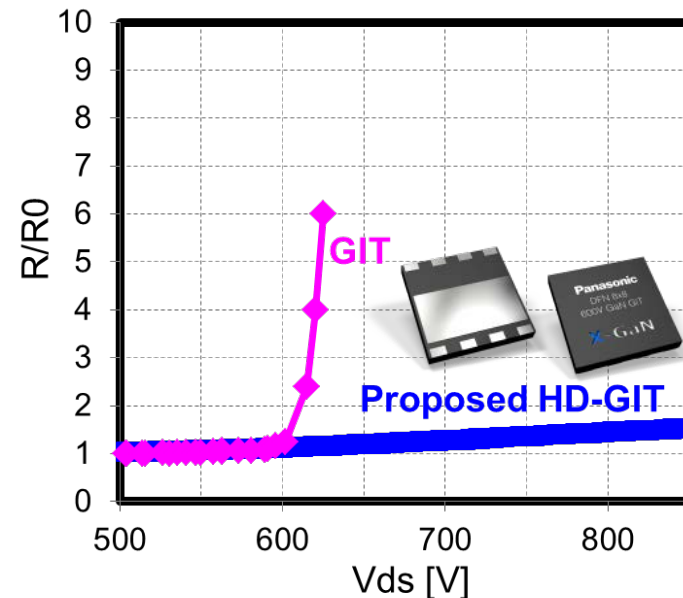
HD-GIT : Hybrid-Drain-embedded Gate Injection Transistor

- HD-GIT has additional p-GaN at the drain to inject holes and to completely suppress the current collapse.
- Recessed-gate with thick AlGaN layer reduces the on-state resistance maintaining the normally-off operation.

Schematic cross section
of HD-GIT



Dynamic R_{on} normalized by DC values (R/R_0)
under inductive load switching



Reliability of HD-GIT Under JEDEC Standard Tests

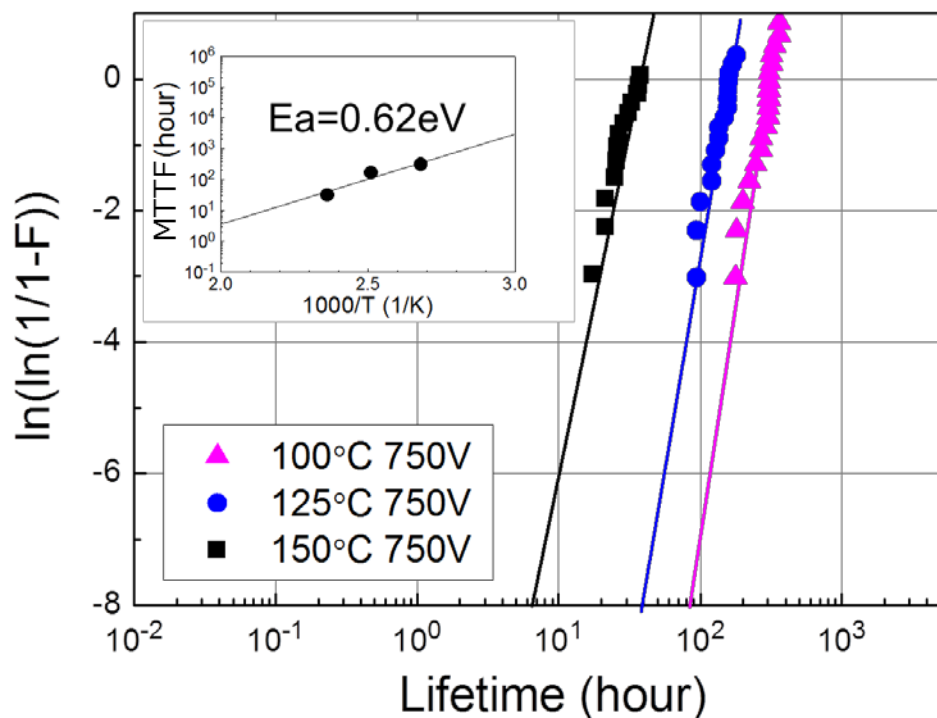
- **HD-GIT passes all of the reliability test standards by JEDEC that have been originally specified for Si power transistors.**

Test Item		Test Condition	JEDEC Standard	Quantity	Result
1	HTRB	Ta=150°C, Vds=480V, t=1000h	JESD22-A108	77 x 3lot	Pass
2	H3TRB	Ta=85°C, RH=85%, Vds=480V, t=1000h	JESD22-A101	77 x 3lot	Pass
3	DC HTGS (Forward)	Tj=150°C, Vgs=4.0V, t=1000h	JESD22-A108	77 x 3lot	Pass
4	DC HTGS (Reverse)	Tj=150°C, Vgs=-12V, t=1000h	JESD22-A108	77 x 3lot	Pass
5	AC HTGS	Continues pulses applied to VGS (max/min=7.7V/-7.2V), 1000h, Tj=150°C	N/A	5 x 1lot	Pass
6	HTS	Ta=150°C, t=1000h	JESD22-A103	77 x 3lot	Pass
7	TC	Ta=-55°C~150°C, 1000cyc, 30min each	JESD22-A104	77 x 3lot	Pass
8	IOL	Ta=25°C, ΔTj=100°C, 12500cyc	JESD22-A105	6 x 1lot	Pass
9	ESD (HBM,CDM)	HBM:C=100pF, R=1.5kohm, ±2000V, CDM: ±2000V	JS-001/JS-002	3 x 3lot	Pass

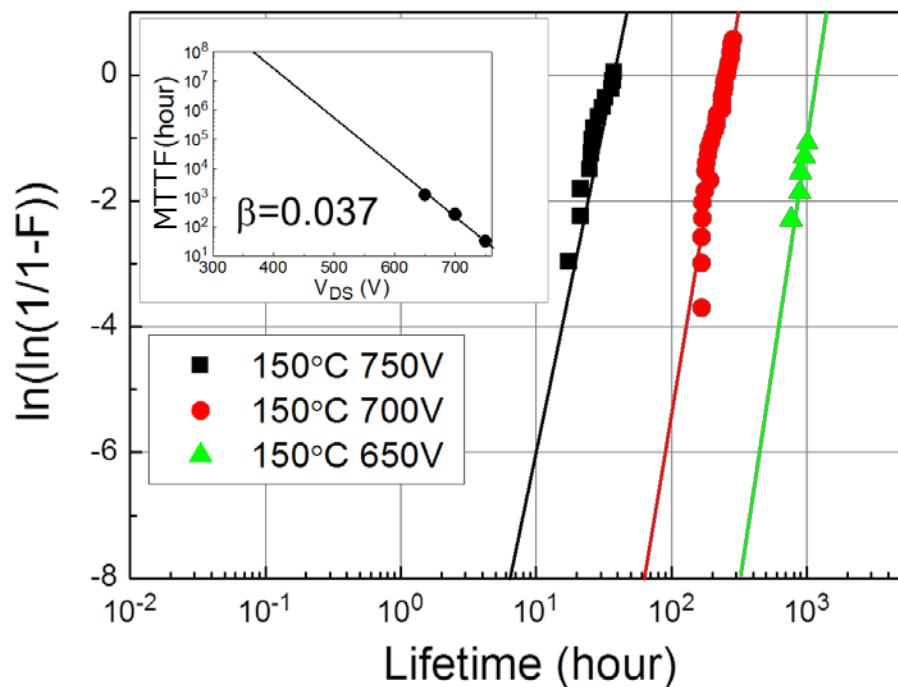
Long Lifetime of HD-GITs Under HTRB Tests

- **Extracted lifetime of high temperature reverse blocking (HTRB) tests at 480V/80°C (80% de-rated from maximum rated blocking voltage) is over 1000 years.**

Weibull plot
for various temperatures



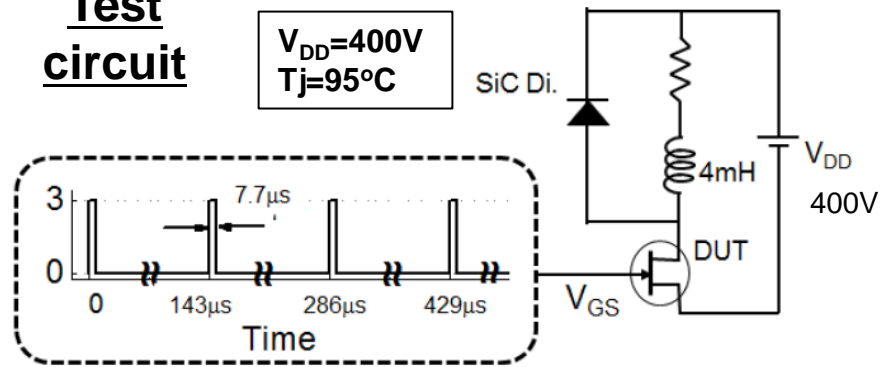
Weibull plot
for various drain voltage



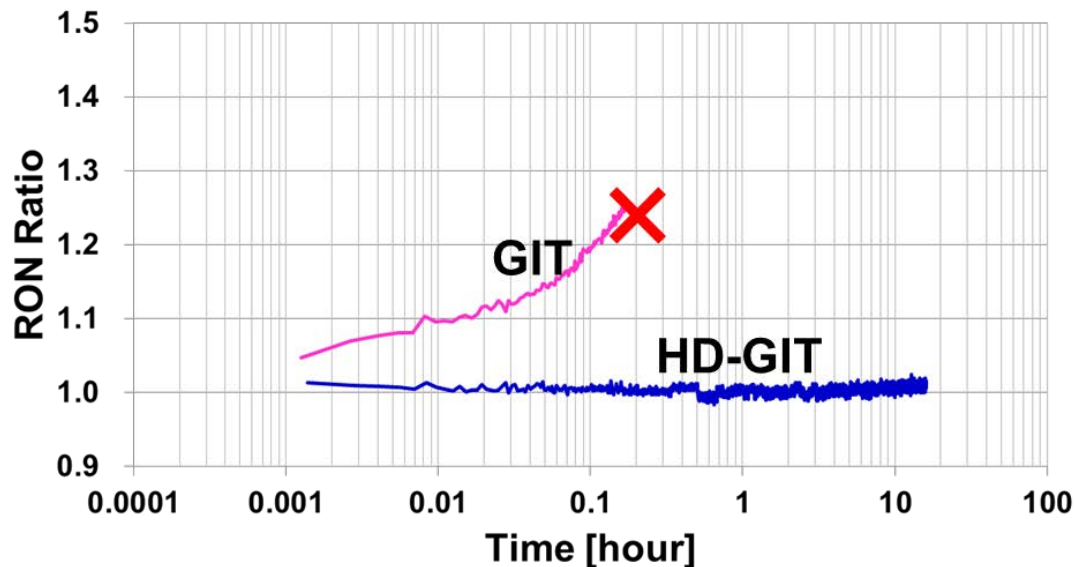
Long Lifetime of HD-GIT Under D-HTOL Tests

- Long lifetime of 3600h is demonstrated by HD-GITs under inductive-load switching reliability tests called as **Dynamic High Temperature Operating Life (D-HTOL)** test.

Test circuit

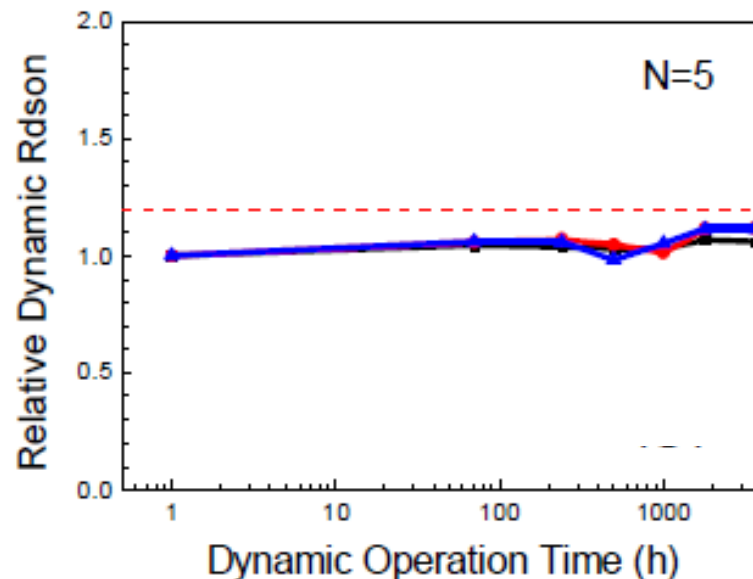


Typical switching reliability test results for HD-GITs and conventional GITs



D-HTOL test results

Dynamic Ron

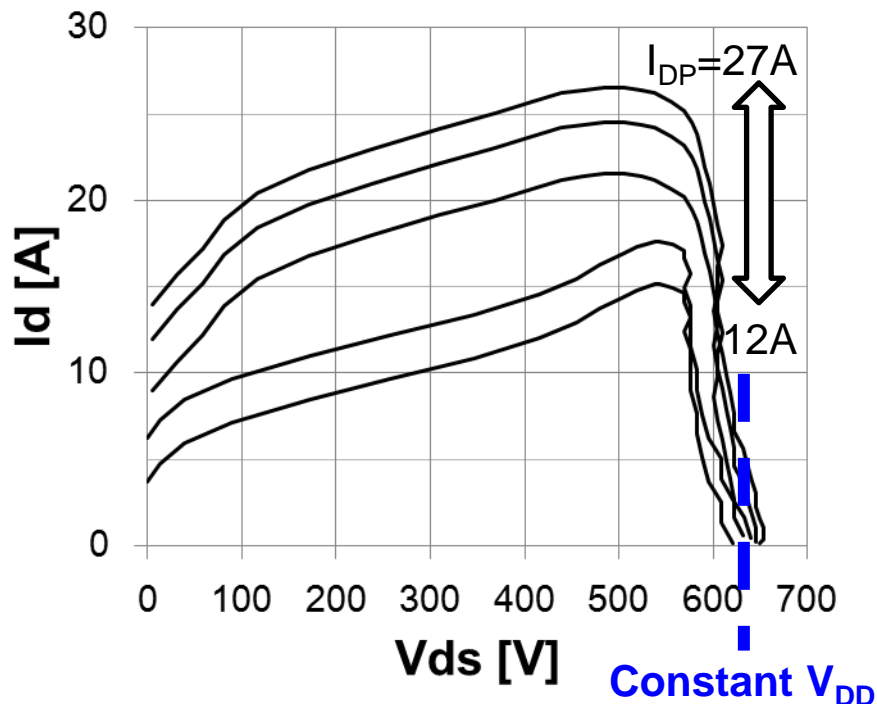


Variation of Current / Voltage Stress in D-HTOL Test

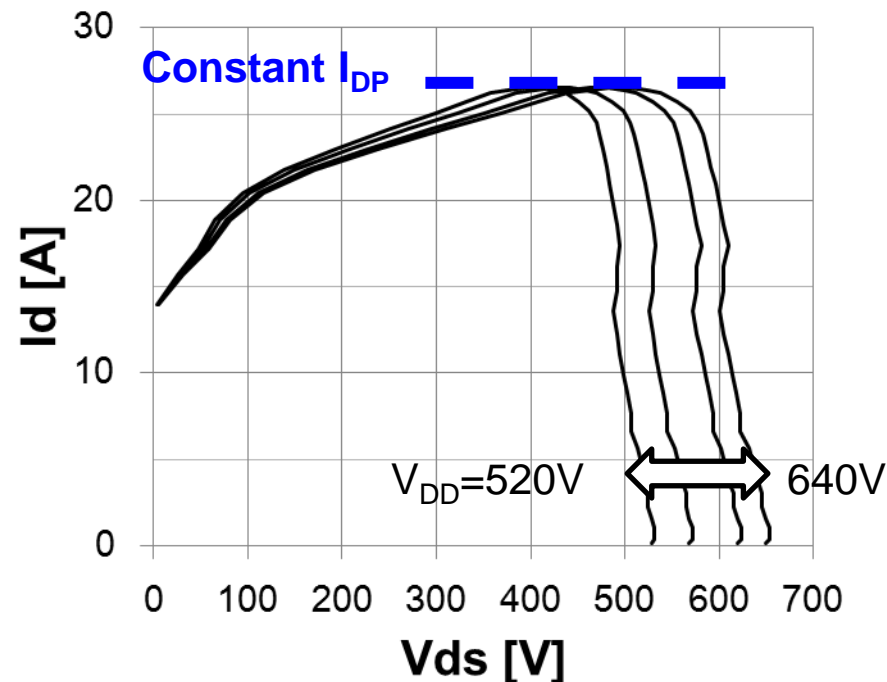
- Applied **current and voltage** as the acceleration parameters **can be independently varied** by adjusting the circuit parameters (L, R) of D-HTOL test circuit.

Variation of switching locus by adjusting circuit parameters

Variation of current with constant voltage



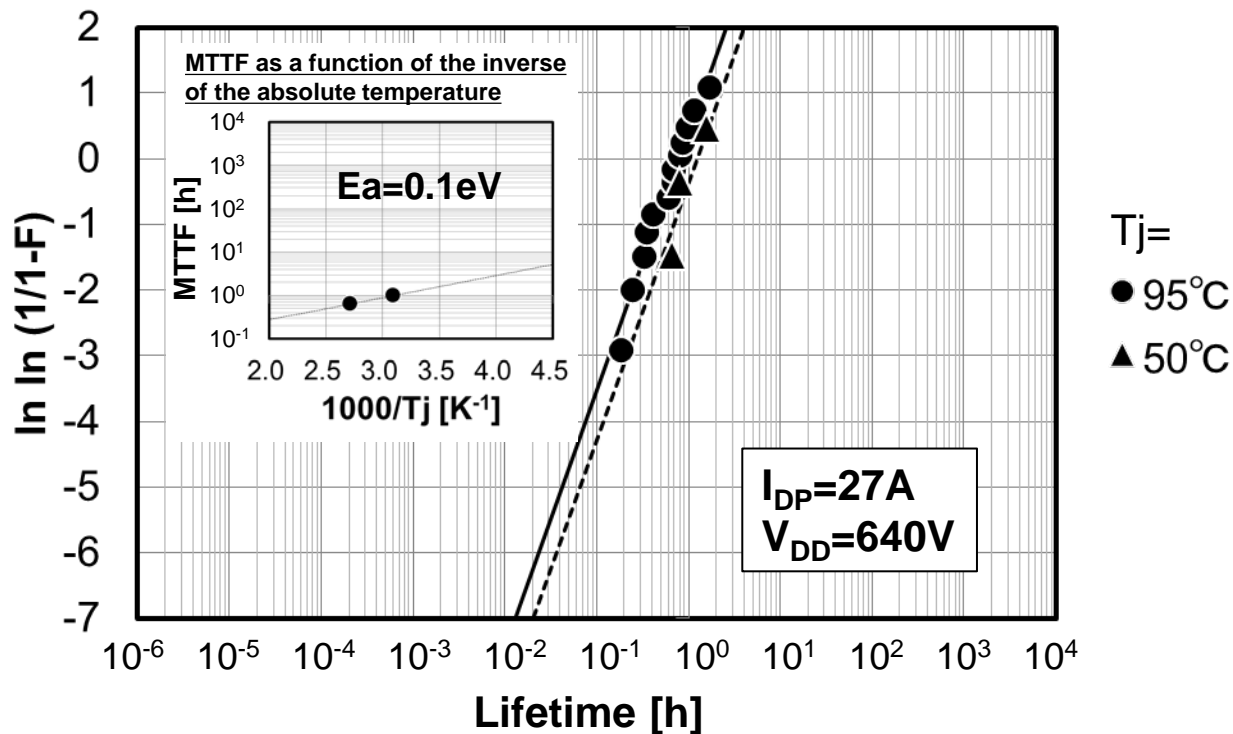
Variation of voltage with constant current



D-HTOL Test Accelerated by Temperature

- Increase of the junction temperature does not affect the lifetime of D-HTOL test for HD-GIT.

Weibull plot for various junction temperatures



D-HTOL Test Accelerated by Drain Current / Voltage

- Increase of drain current /voltage shorten the lifetime of D-HTOL.

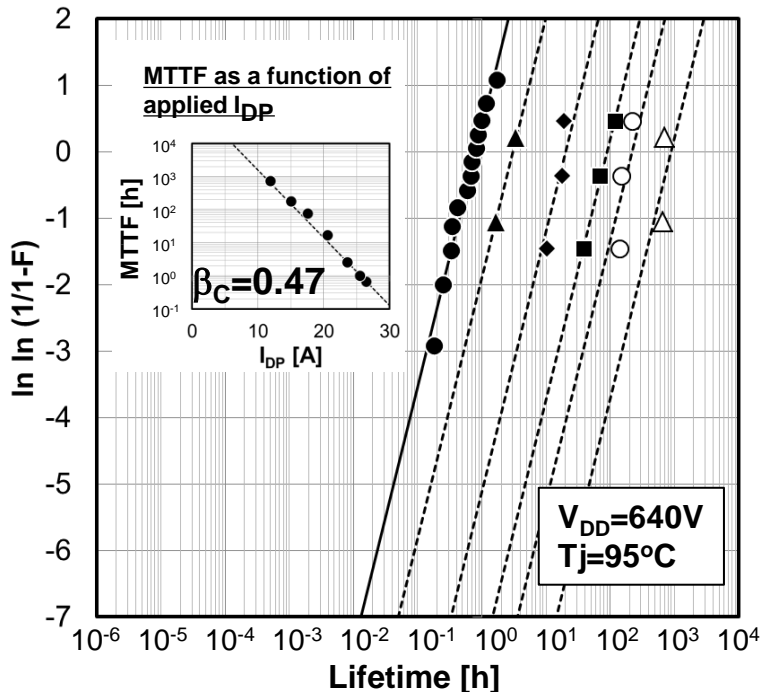
- I_{DP} acceleration factor : $\beta_C=0.47$
- V_{DD} acceleration factor : $\beta_V=0.039$



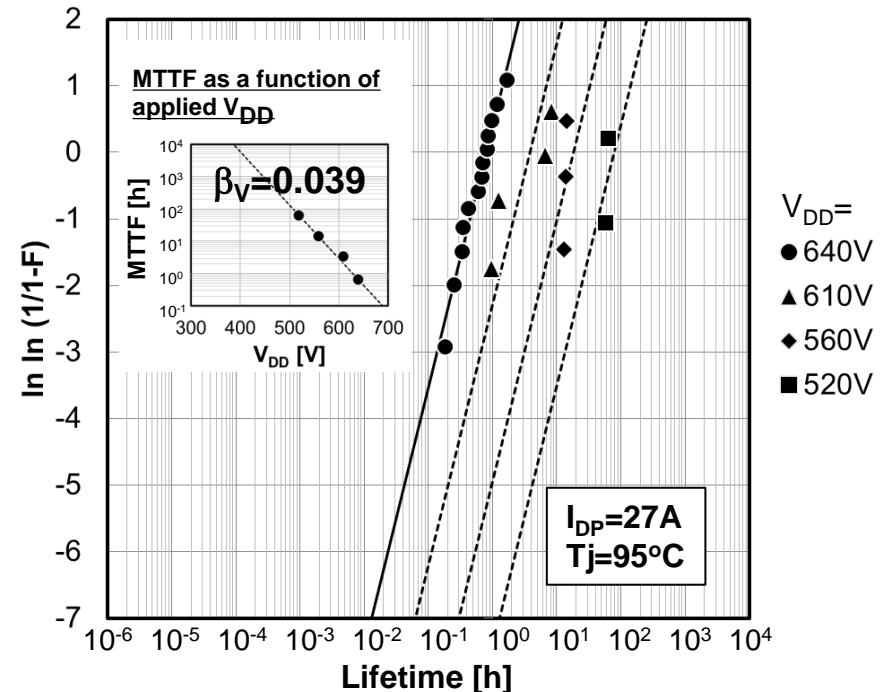
Lifetime of D-HTOL

$$\tau = A \cdot e^{-(\beta_V V_{DD} + \beta_C I_{DP})}$$

Weibull plot for various peak drain current



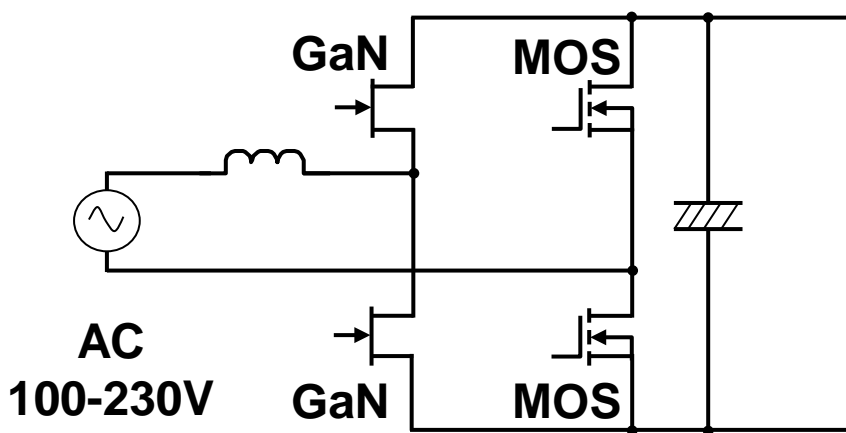
Weibull plot for various drain voltage



Estimation of D-HTOL Lifetime for Totem-pole PFC

- **Totem-pole PFC with GaN HD-GITs** is considered for the estimation of D-HTOL lifetime in practical switching systems.
- The measured lifetime of D-HTOL for HD-GITs at various drain current/voltage is used for the estimation.

Circuit Diagram of Totem-pole PFC with GaN devices



Operating conditions considered for estimation of D-HTOL lifetime

Item	Value
Output power	3kW
Input / Output Voltage	207V(AC 60Hz) / 400V
Frequency	45kHz
Target efficiency	98.5%

Operating Principle of Totem-pole PFC

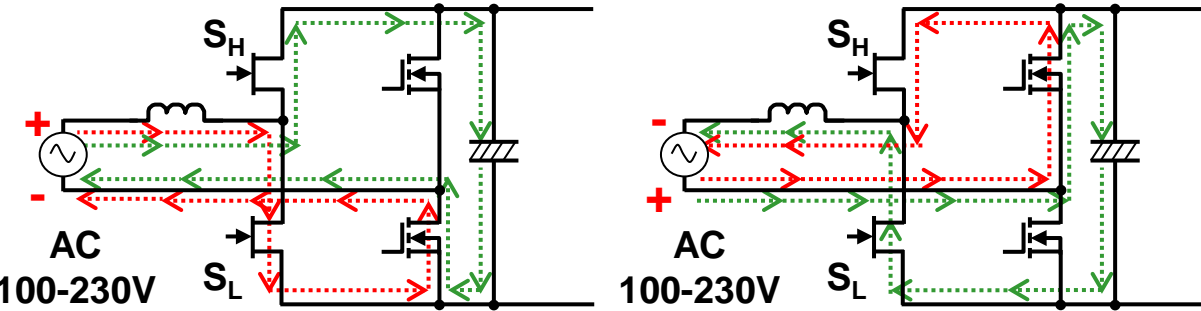
- Two operating half-cycles exist in the operation.
- Forward operations of GaN HD-GITs during the two half-cycles **only need to be considered** for the estimation of the lifetime.

Current paths and switching waveforms of Totem-pole PFC

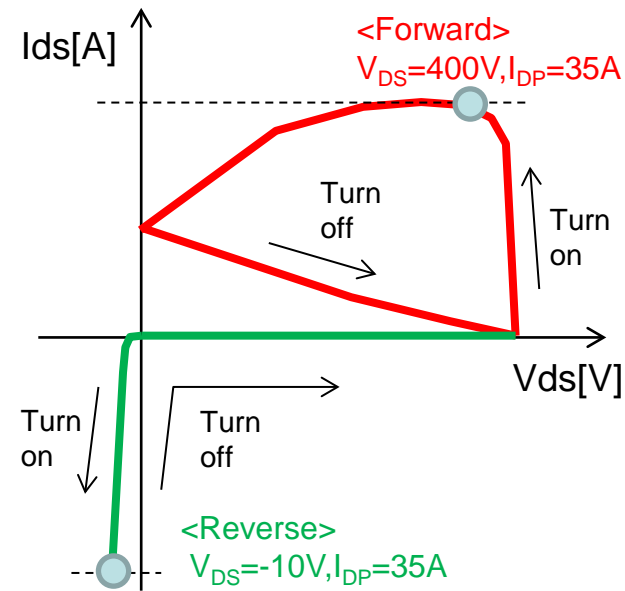
Positive half cycle

Negative half cycle

Current-voltage locus



→ Charge energy to Inductor
→ Deliver energy to Capacitor



	Positive half cycle	Negative half cycle
H-side (S _H)	Reverse (Diode) 	Forward (Switch)
L-side (S _L)	Forward (Switch) 	Reverse (Diode)

Magnitude of operating stress

Reverse	Forward
-10V/35A	400V/35A

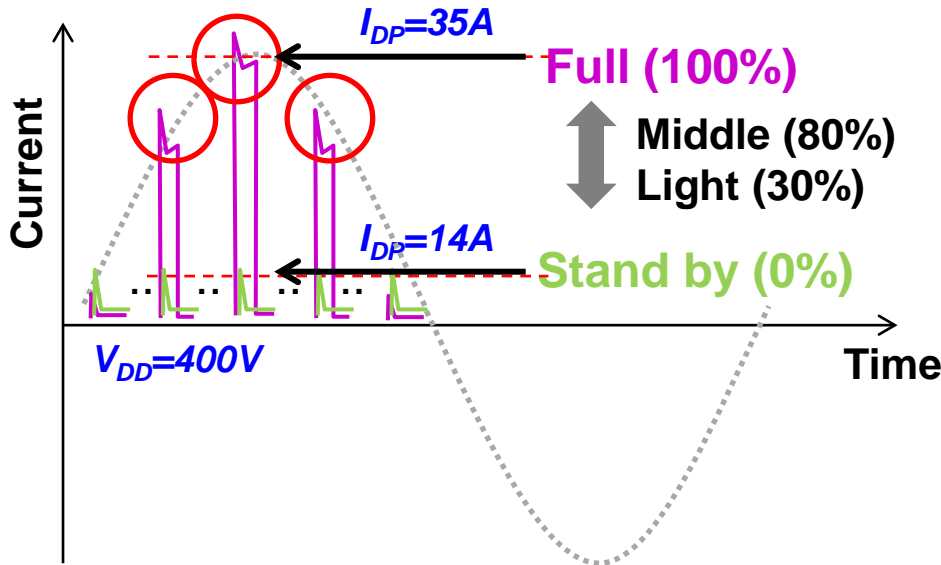
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Reduction of Lifetime by PFC Operation

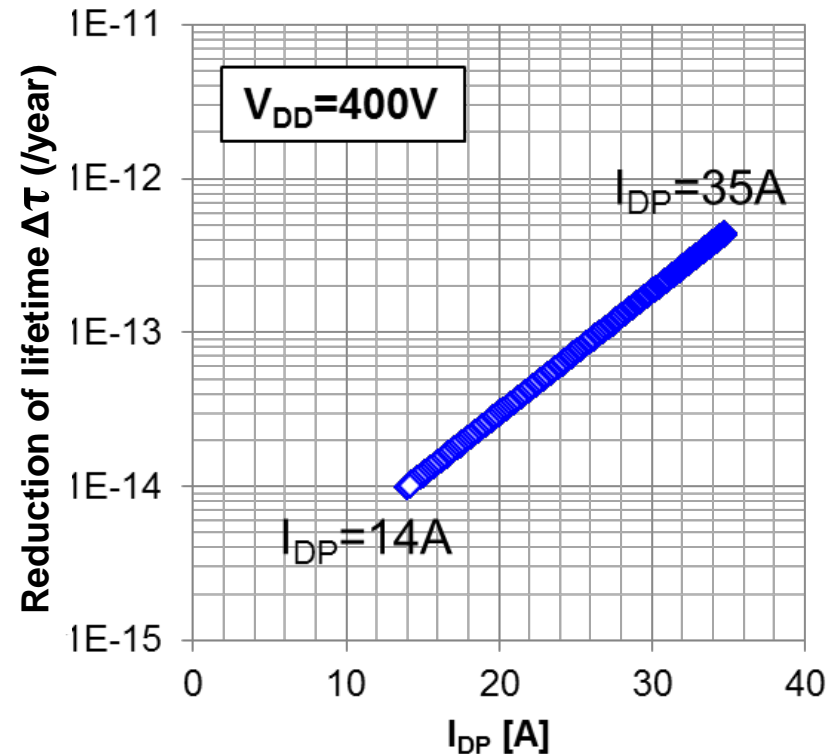
Extraction steps for reduction of the lifetime

- Reduction of lifetime by a single current pulse $\Delta\tau$ is calculated by measured D-HTOL results dependent on V_{DD} and I_{DP}
- $\Sigma\Delta\tau = 1$ indicates that the device reaches catastrophic failure.

Switching waveforms of totem-pole PFC for various load current



Extracted reduction of lifetime

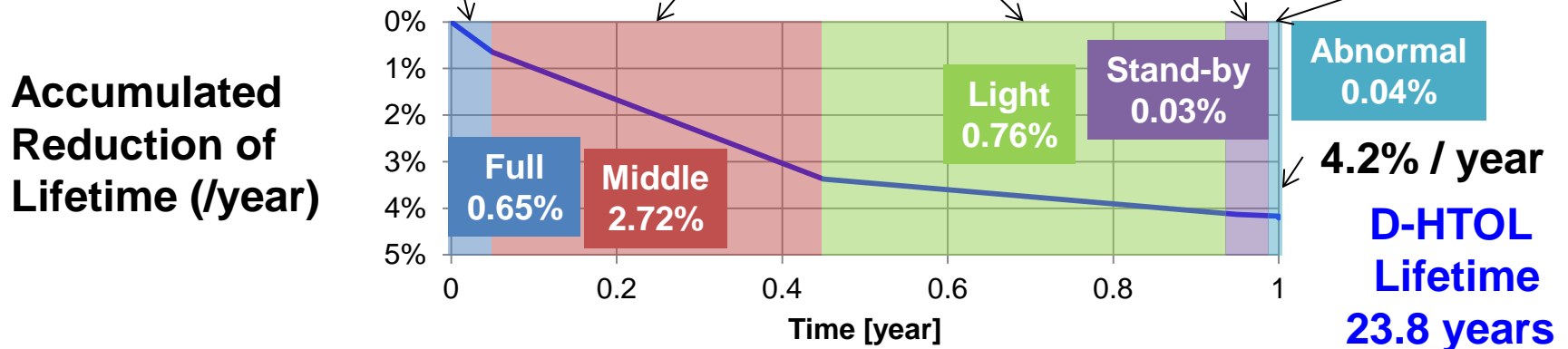


D-HTOL Lifetime for Totem-Pole PFC with HD-GITs

- **D-HTOL lifetime of totem-pole PFC is estimated to be 23.8 years** (=1/0.042) considering the load conditions and the operating fraction.

Reduction of D-HTOL Lifetime Depending on Load Conditions

Load Condition	Full 100% Load	Middle 80% Load	Light 30% Load	Stand-by 0% Load	Abnormal 200% Load
Operating Waveform (Half cycle)	$V_{DD}=400V$ 	$V_{DD}=400V$ 	$V_{DD}=400V$ 	$V_{DD}=400V$ 	$V_{DD}=500V$
Operating fraction	5%	40%	50%	5%	0.0002%



Summary

Demonstration of Highly Reliable Operations by Panasonic's 600V GaN Power Transistors

- **GaN HD-GIT free from current collapse passes all of the reliability test standards by JEDEC.**
- **HD-GIT exhibits long lifetime under switching reliability tests called as D-HTOL with inductive load.**
- **Acceleration factors for the D-HTOL by drain current/voltage are extracted for the estimation of lifetime in practical switching system.**
- **D-HTOL lifetime for totem-pole PFC using GaN HD-GITs are estimated to be as long as 24 years.**

Acknowledgements

- **The authors would like to thank Mr. Hiroyuki Ushihara , Mr. Satoru Takahashi and other members of Panasonic for their supervision and support throughout in this work.**